YDS CAMERA MODULE

your best camera partner

YDS-M3MA-AR1335 PLCC V6.0

13MP OnSemi AR1335 PLCC MIPI Interface Auto Focus Camera Module

Front View

Back View

Specifications

Camera Module No.	YDS-M3MA-AR1335 PLCC V6.0
Resolution	13MP
Image Sensor	AR1335 PLCC
Sensor Type	1/3.2"
Pixel Size	1.1 um x 1.1 um
EFL	3.81 mm
F.NO	2.20
Pixel	4208 x 3120
View Angle	74.4°(DFOV) 62.7°(HFOV) 48.7°(VFOV)
Lens Dimensions	8.50 x 8.50 x 5.60 mm
Module Size	180.00 x 8.50 mm
Module Type	Auto Focus
Interface	MIPI
Auto Focus VCM Driver IC	FP5510
Lens Model	YDS-LENS-50013A1
Lens Type	650nm IR Cut
Operating Temperature	-30°C to +70°C
Mating Connector	BM20B(0.8)-34DS-0.4V(51)

www.YDSCAM.com sales@ydscam.com Phone (WeChat, QQ): (+86) 177 2732 6718

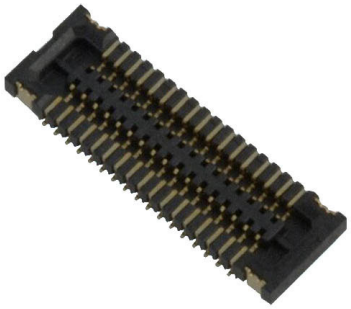
YDS-M3MA-AR1335 PLCC V6.0

13MP OnSemi AR1335 PLCC MIPI Interface Auto Focus Camera Module

Top View

Side View

Bottom View



Mating Connector

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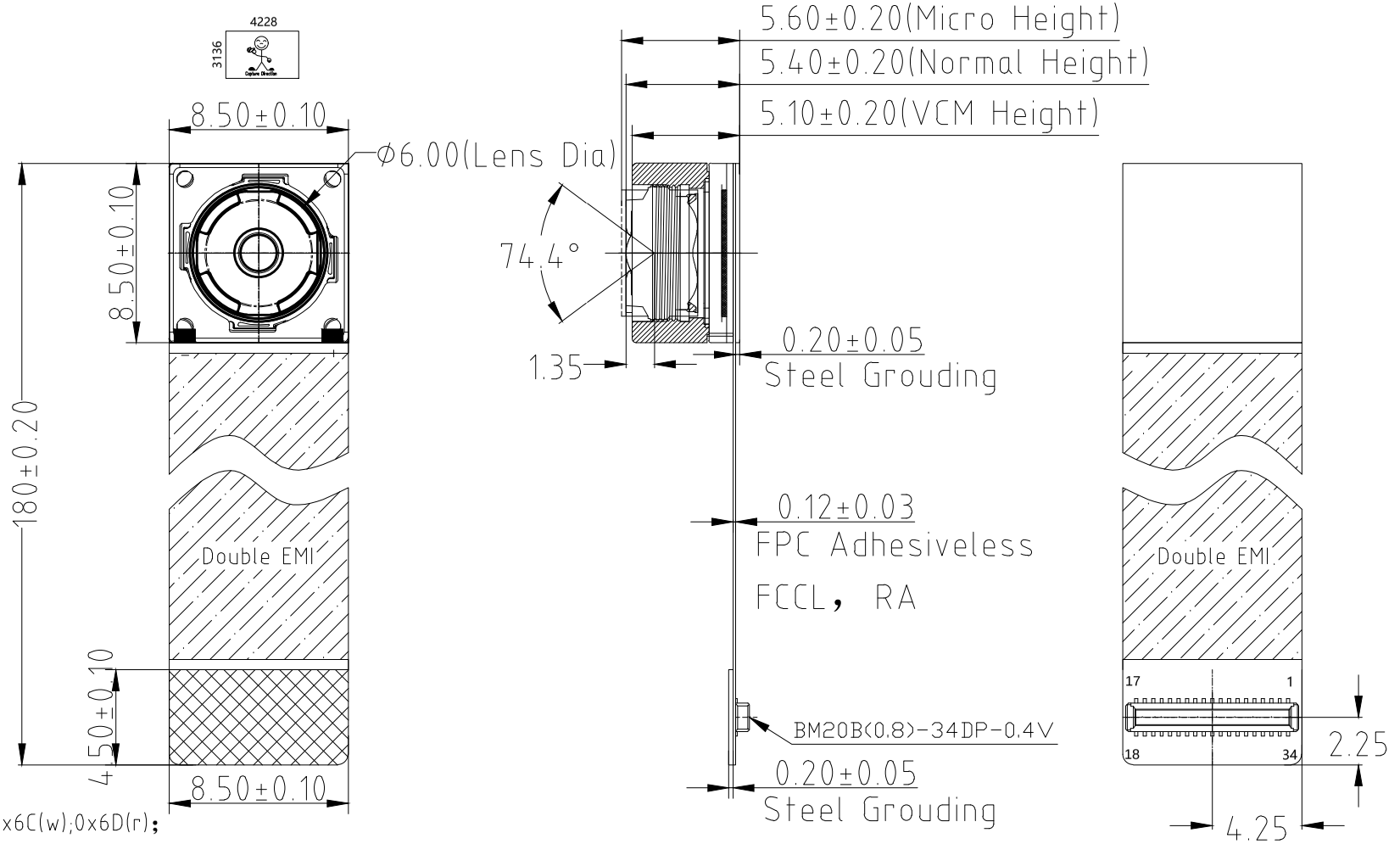
NO	NAME
1	GPIO1
2	DGND
3	DGND
4	DATA_P/SLVS0_P
5	DATA_N/SLVS0_N
6	DGND
7	CLK_P
8	CLK_N
9	DGND
10	DATA4_P/SLVS3_P
11	DATA4_N/SLVS3_N
12	DGND
13	VDDIO 1.8V
14	SCLK
15	GPIO0/FLASH
16	DGND
17	AVDD 2.7V
18	AVDD 2.7V
19	DGND
20	GPI2/Trigger
21	RESET/XSHUTDOWN
22	SDATA
23	VDD 1.2V
24	VDD 1.2V
25	DGND
26	DATA3_N/SLVS2_N
27	DATA3_P/SLVS2_P
28	DGND
29	DATA2_N/SLVS1_N
30	DATA2_P/SLVS1_P
31	DGND
32	EXTCLK
33	DGND
34	AFVDD 2.8V

Version	Information	Date
V6.0	First Version	2021-5-28



NOTE:

1.The device slave address:0x6C(w);0x6D(r);

2.VCM driver IC:CN3927

3.VCM slave ID:0x18

Parameter:

1、Sensor specification:

Image Sensor: AR1335CSSC32SMD20

Pixel: 1.1um×1.1um

Lens Type: 1/3.2

Important Voltage Description: DVDD1.2V (external power supply);

2、Lens specification:

FOV: 74.4°(D);62.7°(H);48.7°(V);

F/NO.: 2.2

TV distortion: <1.5%

Focal length: 3.81mm

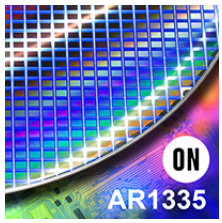
Composition: 5P++IR FILTER

IR Cut Coating: 650nm±10nm@50%

Designed By	Kevin	Model Name:	M3MA-AR1335 PLCC V6.0
Checked By	Aouly_Yan	Projection Type: Third Angle	Unit: mm / Material: ---------- / Scale: 1:1 / Sheet: 1 of 1 / Version: 1/0

Product Overview

AR1335: 13 MP 1/3" CMOS Image Sensor



For complete documentation, see the data sheet.

The AR1335 is a 1/3.2-inch CMOS active-pixel digital image sensor with a pixel array of 4208H x 3120V. The AR1335 digital image sensor, features breakthrough 1.1 m pixel technology that delivers superior low-light image quality through leading sensitivity, quantum efficiency and linear full well. This allows image quality that rivals digital still cameras. With a sensor architecture focused on low power and a high Chief Ray Angle (CRA) for low Z-heights, the AR1335 is ideal for smartphone and other mobile device applications. It incorporates sophisticated on-chip camera functions such as windowing, mirroring, column and row skip modes, and snapshot mode. It is programmable through a simple two-wire serial interface. The AR1335 sensor can generate full resolution image at up to 30 frames per second (fps) and supports advanced video modes including 4K 30fps, 1080P 60fps and 720P 120fps.

Features

- 13MP CMOS sensor with advanced 1.1µm pixel BSI technology
- Data interfaces: 2,3 and 4 lane MIPI
- Bit-depth compression available for MIPI: 10-8 and 10-6 to lower bandwidth
- 3D synchronization controls to enable stereo video capture
- 6.8 kbits one time programmable memory (OTPM)
- Programmable controls: gain, horizontal and vertical blanking, auto black level offset correction, frame size/rate, exposure, left-right and top-bottom image reversal, window size, and panning
- Two on-die phase-locked loop (PLL) oscillators for super low noise performance
- On-chip temperature sensor
- Bayer pattern horizontal down-size scaler
- Simple two-wire fast-mode+ serial interface

  For more features, see the data sheet

Applications

- Mobile
- 4K video capture
- High resolution still capture

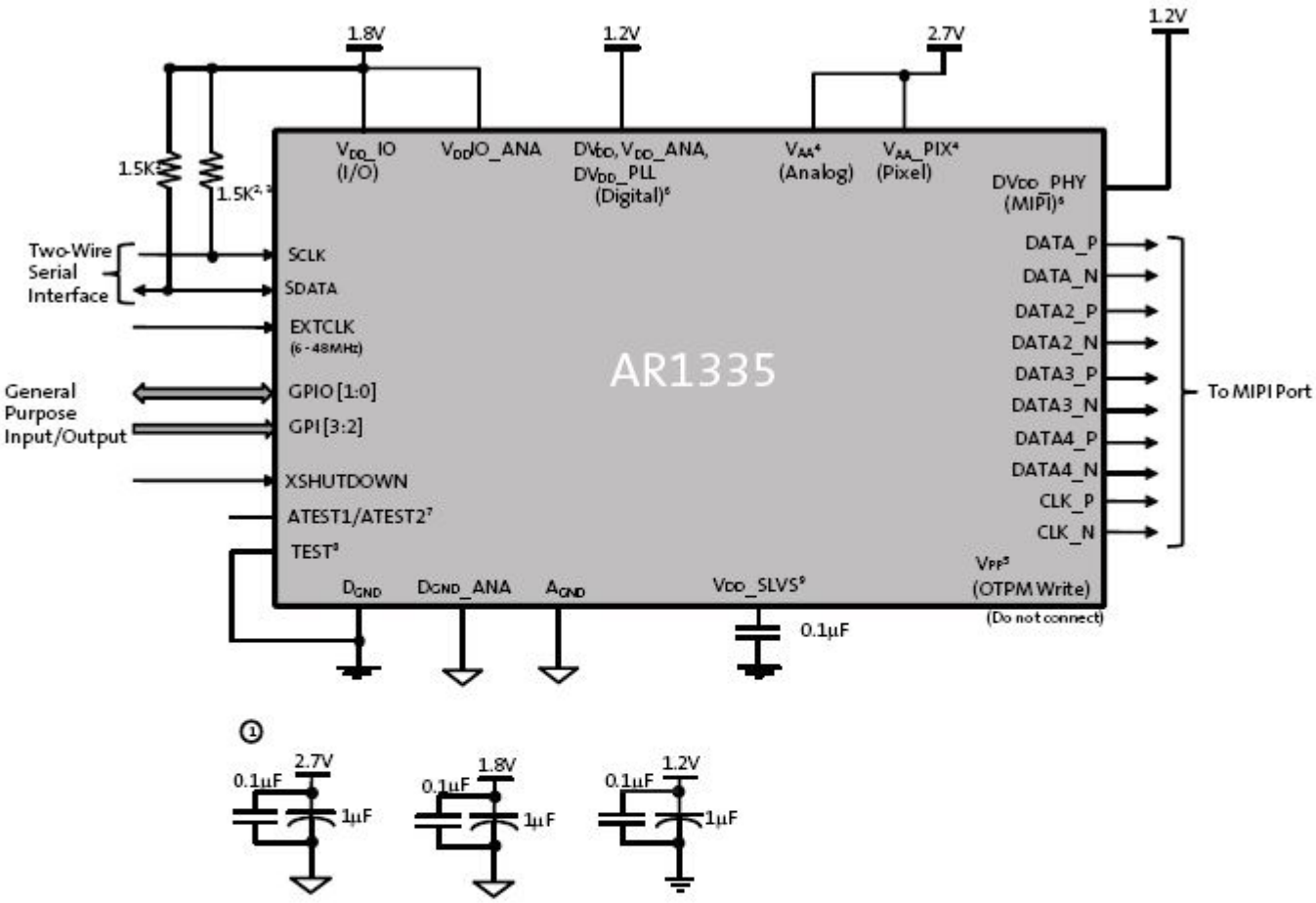
End Products

- Smart Phone
- Digital Still Camera
- PC Camera
- Consumer devices

Part Electrical Specifications

Product	Compliance	Status	Type	Megapixels	Frame Rate (fps)	Optical Format	Shutter Type	Pixel Size (µm)	Output Interface	Color	Package Type
AR1335CSSC11SMD20	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	
AR1335CSSC11SMKA0-CP	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	ODCSP-63
AR1335CSSC11SMKA0-CR	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	ODCSP-63
AR1335CSSC32SMD20	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	
AR1335CSSM11SMD20	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	
AR1335CSSM32SMD20	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	

Application Diagram



For connectivity above:

Notes:
1. All power supplies should be adequately decoupled; recommended cap values are:
   - 2.7V: 1.0µF and 0.1µF
   - 1.2V: 1.0uF and 0.1µF
   - 1.8V: 1.0uF and 0.1µF
2. Resistor value 1.5kΩ is recommended, but may be greater for slower two-wire speed.
3. This pull-up resistor is not required if the controller drives a valid logic level on SCLK at all times.
4. VAA and VAA_PIX must be tied together.
5. Internal charge pump is used for OTPM programming.
6. Digital and MIPI supply can be tied together.
7. ATEST1/ATEST2 must be left floating.
8. TEST pin must be tied to DGND.
9. VDD_SLVS must be connected to DGND through a bypass cap (0.1uF).

For more information please contact your local sales support at www.onsemi.com.

Created on: 9/30/2017

1/3.2-Inch 13 Mp CMOS Digital Image Sensor

AR1335 Datasheet, Rev. A

For the latest datasheet, please visit: www.aptina.com

Features

- 13 Mp CMOS sensor with advanced 1.1 µm pixel BSI technology
- Data interfaces: two-, three-, and four-lane serial mobile industry processor interface (MIPI)
- Bit-depth compression available for MIPI Interface: 10-8 and 10-6 to enable lower bandwidth receivers for full frame rate applications
- 3D synchronization controls to enable stereo video capture
- 6.8 kbits one-time programmable memory (OTPM) for storing shading correction coefficients and module information
- Programmable controls: gain, horizontal and vertical blanking, auto black level offset correction, frame size/rate, exposure, left-right and top-bottom image reversal, window size, and panning
- Two on-die phase-locked loop (PLL) oscillators for super low noise performance
- On-chip temperature sensor
- Bayer pattern horizontal down-size scaler
- Simple two-wire fast-mode+ serial interface
- Low dark current
- Interlaced multi-exposure readout enabling High Dynamic Range (HDR) still and video applications
- On-chip lens shading correction
- Support for external mechanical shutter
- Support for external LED or Xenon Flash
- Extended Flash duration up to start of frame readout

Applications

- Cellular phones
- Digital still cameras
- PC cameras
- PDAs

Table 1: Key Performance Parameters

Parameter		Value
Optical format		1/3.2 -inch 13 Mp (4:3)
Active pixels		4208H x 3120V
Pixel size		1.1µm Back Side Illuminated (BSI)
Chief ray angle (CRA)		32°
Die size		6.3 mm x 5.7 mm
Input clock frequency		6 - 48 MHz
Interface		4-lane MIPI (2- and 3-lane supported); Max data rate: 1.2Gbps/lane
Subsampling modes (column and row)		skip2 bin2 skip3 bin3 skip4 bin4 skip2bin2
ADC resolution		10 bits, on-die
Analog gain		1x – 7.75x
Digital gain		Up to 7.98x
Scaler		Adjustable scaling up to 8x
Temperature sensor		10-bit, controlled by two-wire serial I/F
Compression		DPCM: 10-8-10, 10-6-10
3D support		Frame rate and exposure synchronization
Supply voltage	V_{AA}, V_{AA_PIX}	2.6 - 2.9 V (2.7 V nominal)
	V_{DD_IO}, V_{DDIO_ANA}	1.7 - 1.9 V (1.8 V nominal)
	V_{DD}, V_{DD_ANA}, V_{DD_PLL}, V_{DD_PHY}	1.14 - 1.3 V (1.2 V nominal)
Power consumption		270 mW at 60°C (TYP) at 13 Mp 30 fps
Responsivity		4700 e^-/lux-sec
SNR_{MAX}		37 dB
Dynamic Range		69 dB
Operating Temperature Range (at junction) - T_J		-30°C to +70°C

Table 2: Mode of Operation and Power

Mode	Resolution	Readout Configuration	HFOV	FPS	Power Consumption [mW]
4:3 Snapshot Mode					
13 M full resolution	4208x3120	13M full mode	100%	30	270
13 M full resolution	4208x3120	13M full mode	100%	24	250
VGA	640 x 480	Crop+Subsampling+Scaling	61%	120	190
QVGA	320 x 240	Crop+Subsampling+Scaling	30%	240	165
16:9 Video Mode 30 FPS					
4K UHD	3840 x 2160	Cropping	91%	30	230
4K Cinema	4096 x 2160	Cropping	97%	30	235
1080p	1920 x 1080	Crop+Subsampling+Scaling	91%	30	160
1080p LP	1920 x 1080	Crop+Subsampling+Scaling	91%	30	135
720p	1280 x 720	Crop+Subsampling+Scaling	91%	30	140
16:9 Video Mode 60 FPS					
1080p	1920 x 1080	Crop+Subsampling+Scaling	91%	60	210
1080p LP	1920 x 1080	Crop+Subsampling+Scaling	91%	60	180
720p	1280 x 720	Crop+Subsampling+Scaling	91%	60	175
3M 30 FPS					
3M	2000 x 1500	Crop+Subsampling+Scaling	95%	30	195
3M LP	2000 x 1500	Crop+Subsampling+Scaling	95%	30	170
16:9 Video Mode 120 FPS					
720p	1280 x 720	Crop+Subsampling+Scaling	91%	120	260

Ordering Information

Table 3: Available Part Numbers

Part Number	Description
AR1335CSSC32SMD20	Bare die

FP5510

10-Bit DAC 120mA VCM Driver with I²C Interface

Description

The FP5510 is a single 10-bit DAC with 120mA output current voice coil motor (VCM) driver, with an I²C-compatible serial interface that operates at clock rates up to 400kHz. Its supply operates from 2.3V to 3.6V.

The FP5510 incorporates with a power-on reset circuit, power-down function. Power-on reset circuit ensure when supply power up, DAC output is to 0V until valid write bit value takes place. In power down mode, the supply current is about 1μA.

The FP5510 is designed for auto focus operation includes digital camera module, optical zoom camera phones and lens auto focus. The I²C address of FP5510 is 0x18h.

The FP5510 with WLCSP package which it is suitable for reduced-space mounting in mobile phone and other portable applications.

Features

- Power Supply Voltage Rang: 2.3V to 3.6V
- VCM Driver for Auto-Focus
- 10-Bit Resolution Current Sinking of 120mA for VCM
- 2-Wire I²C Interface (1.8V Interface Compatible)
- Internal 4 Slope Control Mechanism
  1. Enhance Slope Control Mode
  2. One Step Mode
  3. Linear Slope Mode
  4. Two Step Slope Mode
- Power-Save Mode Current < 1μA
- Power On Reset (POR)
- Small Size: 0.7mm×1.1mm (6-Balls WLCSP)

Applications

- Digital Camera Module
- Cell Phone
- Lens Cover
- Web Camera

Pin Assignments

6-Ball WLCSP

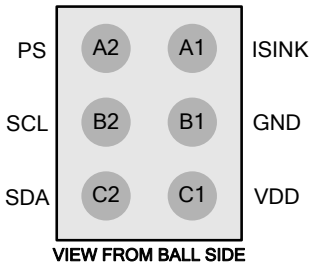


Figure 1. Pin Assignment of FP5510

Ordering Information

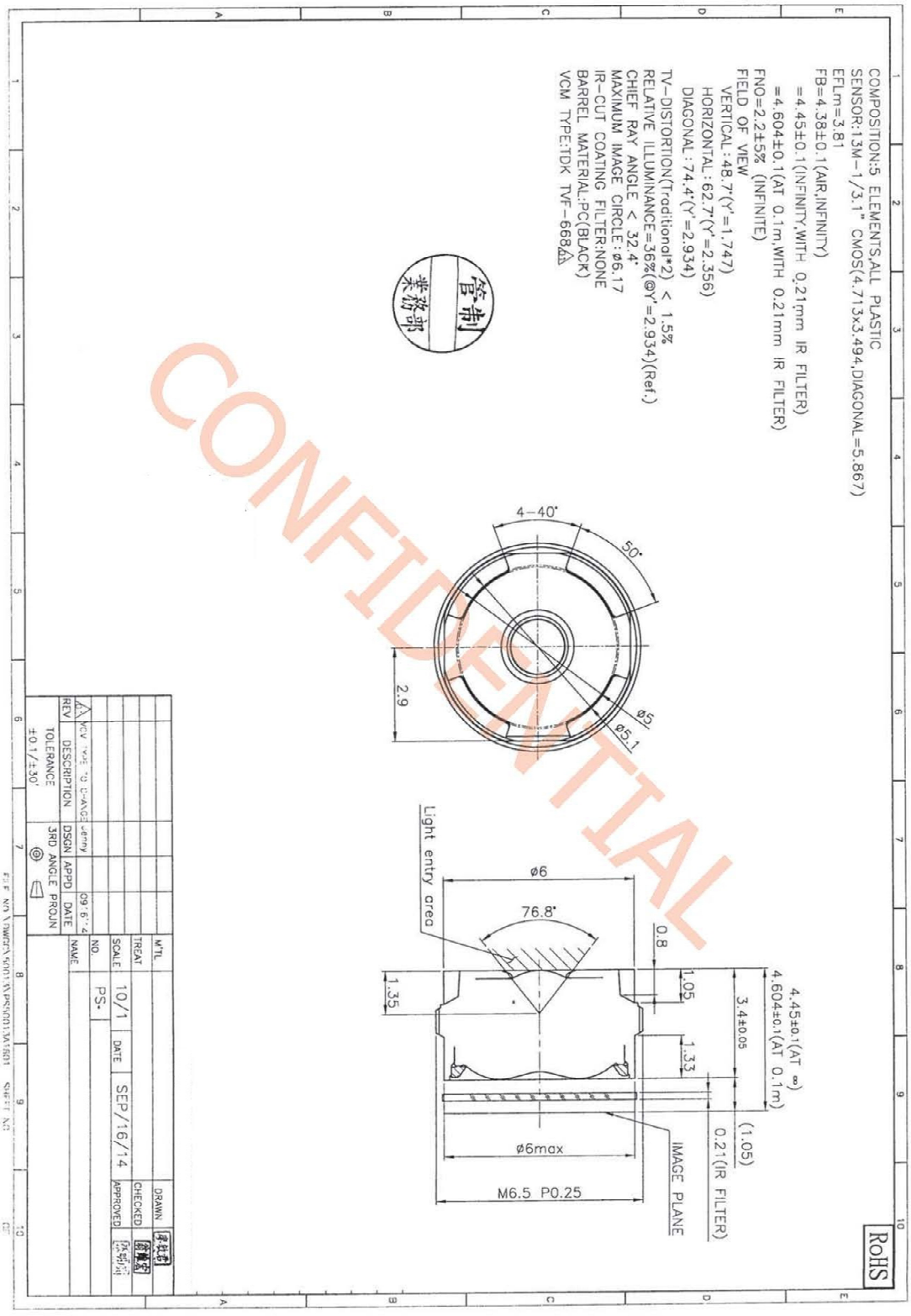
FP5510□

Package Type
E2: WLCSP (6-Ball)

WLCSP-6 (0.7mmx1.1mm) Marking

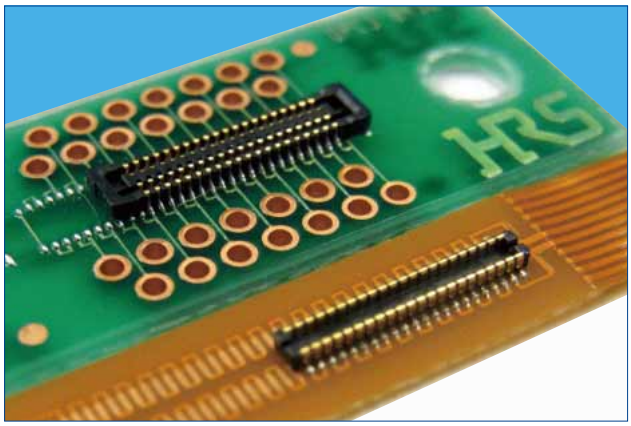
Part Number	Product Code
FP5510E2	2

YDS-LENS-50013A1

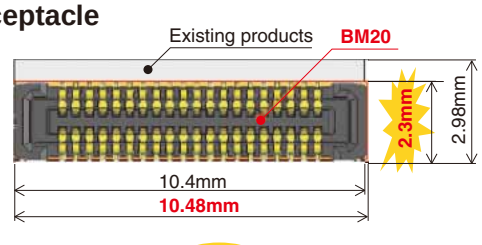


0.4mm Pitch, 0.6 and 0.8mm Height, Board-to-Board and Board-to-FPC Connectors

BM20 Series



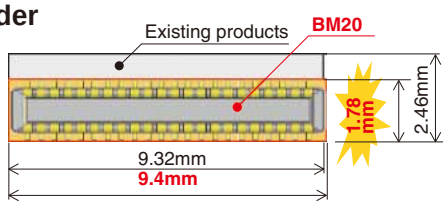
■Receptacle



A 22.3% reduction in size!

Existing products	BM20
2.98 × 10.4 =About 31.0mm²	2.3 × 10.48 = About 24.1mm²

■Header

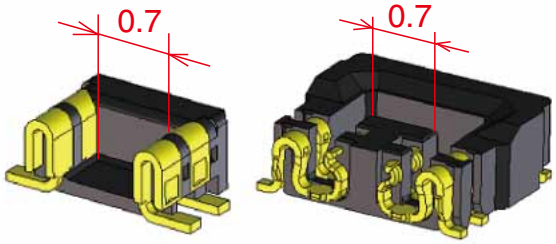


Board occupied area

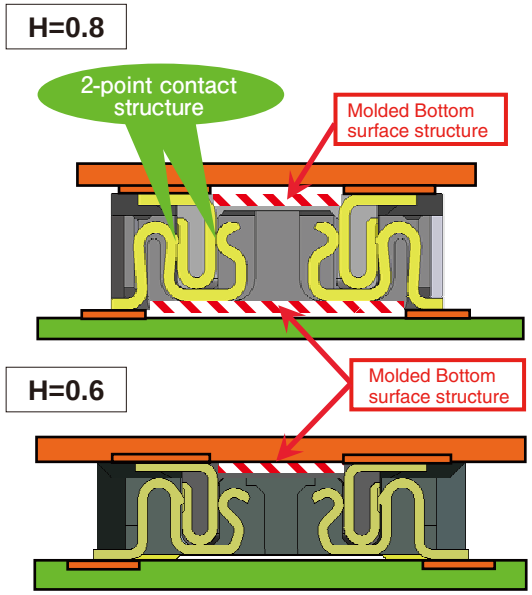
A 27.1% reduction in size!

Existing products	BM20
2.46 × 9.32 = About 22.9mm²	1.78 × 9.4 = About 16.7mm²

Vaccum pick-up



Mating diagram (cross section)



■Features

1. High density mounting capability

A space saving design that keeps the connector compact, but still maintains an adequate vacuum area (no less than 0.7mm wide).
Depth DS : 2.3mm DP : 1.78mm

2. Reliable contact performance

Even though the mated height is low, the BM20 still leads it class in maximum effective mating lengths for each mating height.
<Effective Mating Length>
Height 0.8mm : 0.2mm
Height 0.6mm : 0.15mm
The addition of the two point contact system adds more reliability to the contacts.

3. No restrictions to PCB pattern design for the 0.8 mm height connector *1

This series utilizes a thin wall to insulate the bottom surface of the connector and maintains an effective mating length of 0.2mm. This removes any restriction for PCB pattern layout design under the connector.
Note *1: There are some restrictions for the 0.6 mm height style.

4. Enhanced mating operations

The structure uses guide ribs to ease the mating process and offers a self alignment range of up to 0.3mm. A clear tactile click is used as an indicator to the user that the mating process was completed.

5. Drop and shock resistant structure

Dimples were designed into the contacts to increase their retention force and to absorb the shock delivered from a drop or other impact.

6. Debris resisting design

When mated, the connector's design covers the contacts which help to keep dust and other debris away from the contacts. The SMT leads are kept very close to the connector housing which also helps to prevent shorts caused by debris on the exposed contacts

■Product Specifications

Ratings	Rated Current	0.3A	Operating Temperature Range	- 35 ～ 85°C (Note 1)	Storage Temperature Range	- 10 ～ 60°C (Note 2)
	Rated Voltage	AC, DC 30V	Operating Humidity Range	20 ～ 80%	Storage Humidity Range	40 ～ 70% (Note 2)

Items	Specifications	Conditions
1. Insulation Resistance	Minimum of 50MΩ	Measured with DC 100V
2. Withstanding Voltage	No flashover or breakdown	Apply AC 100V for 1 minute
3. Contact Resistance	Maximum of 100mΩ	Measured with AC 20 mV, 1 kHz and 1 mA
4. Vibration Resistance	No electrical discontinuity of 1μs or greater	Frequency 10-55 Hz, half amplitude 0.75mm, 3 directions for 2 hours
5. Humidity Resistance	Contact resistance Maximum of 100mΩ Insulation resistance Minimum of 25mΩ	Left at temperature 40±2℃, humidity 90 to 95%, 96 hours
6. Temperature Cycles	Contact resistance Maximum of 100mΩ Insulation resistance Minimum of 50mΩ	(-55°C : 30 minutes → 5～35℃ : 10 minutes → 85°C : 30 minutes → 5～35℃ : 10 minutes) 5 cycles
7. Durability	Contact Resistance: maximum of 100mΩ	10 mating cycles
8. Soldering Heat Resistance	Should be no melting of resin parts that affects its performance	Reflow : according to the Recommended Solder Profile Hand solder : Soldering iron temperature 350°C, no more than 3 seconds.

Note 1 : Includes temperature rise caused by current flow.

Note 2 : The term "storage" here refers to products stored for a long period prior to board mounting and use. The operating temperature and humidity range covers the non-energized condition of connectors after board mounting and the temporary storage conditions during transportation, etc.

■Materials

Product	Component	Materials	Finish	UL Regulation
Receptacle	Insulator	LCP	Black	UL94V-0
Header	Contact	Phosphorous bronze	Gold plating	————

■Product Number Structure

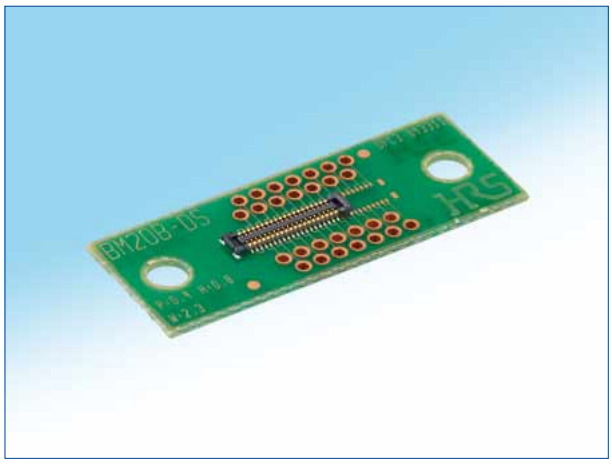
Refer to this page when determining product specifications by model types. Please place orders with part numbers listed in this catalog. The characteristics and specifications of the product described in this catalog are reference values. Please make sure to check the latest delivery specifications at the time of product use.

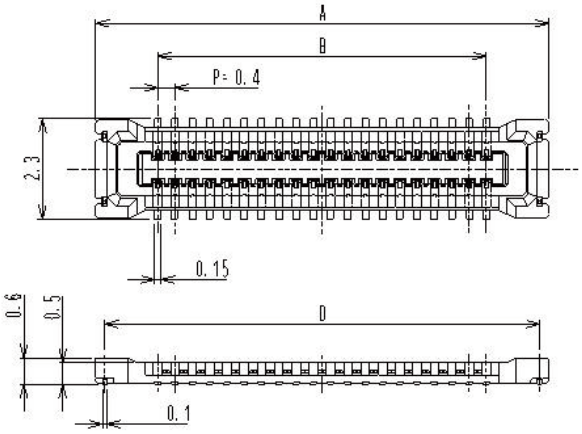
●Receptacle/Header

BM ❶ 20 ❷ # ❸ (**) ❹ - * ❺ DS ❻ - 0.4 ❼ V ❽ (51) ❾

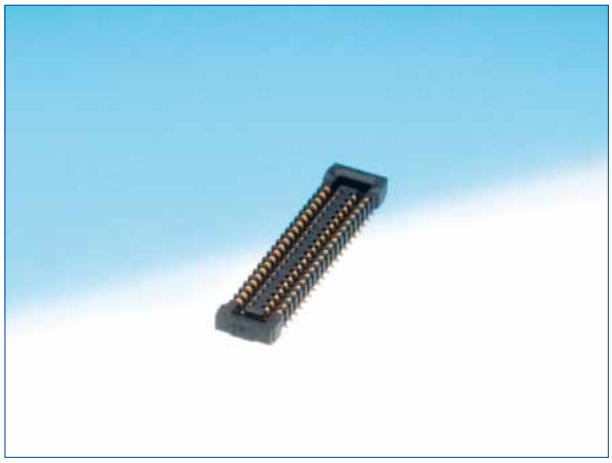
❶ Series Name : BM	❻ Connector Type DS : Double row receptacle DP : Double row header
❷ Series No. : 20	
❸ Shape Symbols B : With reinforcing metal fitting	❼ Contact Pitch : 0.4mm
❹ Stack height : 0.6mm, 0.8mm	❽ Terminal Shape V : Vertical SMT
❺ No. of Contacts : Please refer to page 3 and after.	❾ Packaging (51) : Embossed tape package (8,000 pieces per reel)

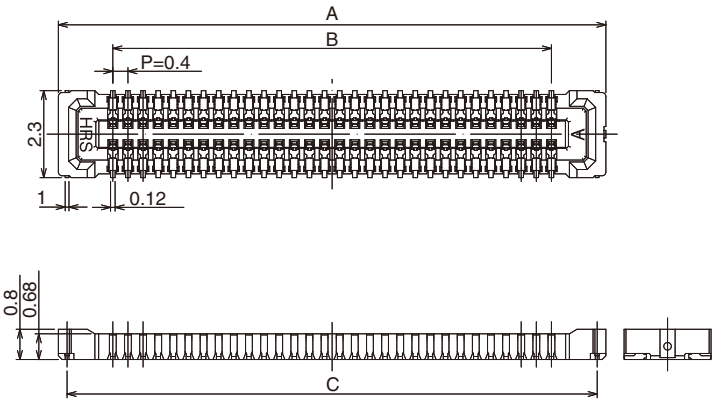
■H=0.6mm receptacle



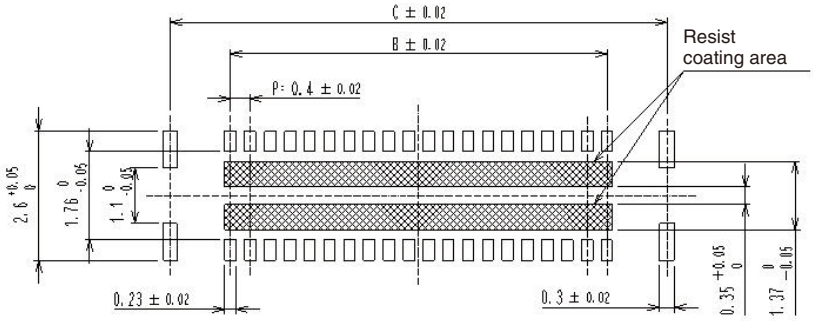


■H=0.8mm receptacle

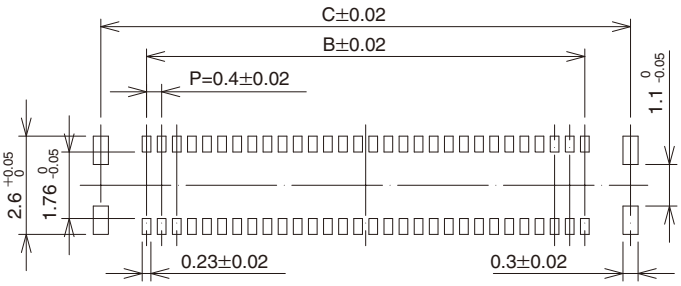




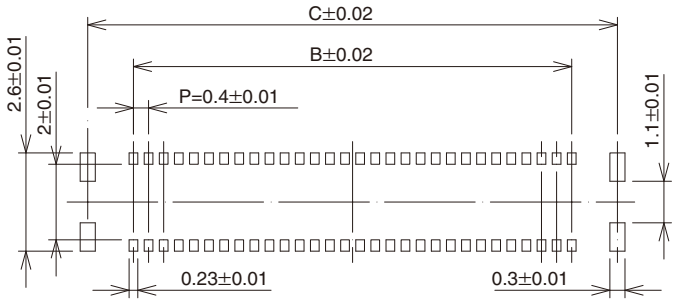
◆Recommended PCB layout【H= 0.6mm】



◆Recommended PCB layout【H= 0.8mm】



◆Recommended metal mask size (Mask thickness 100 µm)【0.6 mm and 0.8 mm common】



Unit : mm

Part No.	HRS No.	No. of Contacts	A	B	C	D
BM20B(0.6)-10DS-0.4V(51)	0684-9308-8 51	10	4.48	1.6	4.02	4.06
BM20B(0.6)-20DS-0.4V(51)	0684-9309-0 51	20	6.48	3.6	6.02	6.06
BM20B(0.6)-24DS-0.4V(51)	0684-9310-0 51	24	7.28	4.4	6.82	6.86
BM20B(0.6)-30DS-0.4V(51)	0684-9311-2 51	30	8.48	5.6	8.02	8.06
BM20B(0.6)-34DS-0.4V(51)	0684-9312-5 51	34	9.28	6.4	8.82	8.86
BM20B(0.6)-40DS-0.4V(51)	0684-9313-8 51	40	10.48	7.6	10.02	10.06
BM20B(0.6)-50DS-0.4V(51)	0684-9314-0 51	50	12.48	9.6	12.02	12.06
BM20B(0.6)-60DS-0.4V(51)	0684-9315-3 51	60	14.48	11.6	14.02	14.06

Part No.	HRS No.	No. of Contacts	A	B	C
BM20B(0.8)-10DS-0.4V(51)	0684-9008-4 51	10	4.48	1.6	4.02
BM20B(0.8)-16DS-0.4V(51)	0684-9041-0 51	16	5.68	2.8	5.22
BM20B(0.8)-20DS-0.4V(51)	0684-9009-7 51	20	6.48	3.6	6.02
BM20B(0.8)-24DS-0.4V(51)	0684-9010-6 51	24	7.28	4.4	6.82
BM20B(0.8)-30DS-0.4V(51)	0684-9011-9 51	30	8.48	5.6	8.02
BM20B(0.8)-34DS-0.4V(51)	0684-9020-0 51	34	9.28	6.4	8.82
BM20B(0.8)-40DS-0.4V(51)	0684-9012-1 51	40	10.48	7.6	10.02
BM20B(0.8)-50DS-0.4V(51)	0684-9013-4 51	50	12.48	9.6	12.02

Note 1 : This product is sold by full reel quantities of 8,000 pieces per reel. Please place orders in full reel quantities.
Note 2 : This connector is NOT polarized.

Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors	
Pin Signal	**Description**
DGND GND	ground for digital circuit
AGND	ground for analog circuit
PCLK DCK	DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK	system input clock
RESET RST	reset active low with internal pull-up resistor
NC NULL	no connect
SDA SIO_D SIOD	SCCB data
SCL SIO_C SIOC	SCCB input clock
VSYNC XVS FSYNC	DVP VSYNC output
HREF XHS	DVP HREF output
DOVDD	power for I/O circuit
AFVDD	power for VCM circuit
AVDD	power for analog circuit
DVDD	power for digital circuit
STROBE FSTROBE	strobe output
FSIN	synchronize the VSYNC signal from the other sensor
SID	SCCB last bit ID input
ILPWM	mechanical shutter output indicator
FREX	frame exposure / mechanical shutter
GPIO	general purpose inputs
SLASEL	I2C slave address select
AFEN	CEN chip enable active high on VCM driver IC
MIPI Interface	
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA_P DMO1P	MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2_N DMO2N	MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2_P DMO2P	MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3_N DMO3N	MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3_P DMO3P	MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4_N DMO4N	MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN	MIPI clock negative output
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output
DVP Parallel Interface	
D0 DO0 Y0	DVP data output port 0
D1 DO1 Y1	DVP data output port 1
D2 DO2 Y2	DVP data output port 2
D3 DO3 Y3	DVP data output port 3
D4 DO4 Y4	DVP data output port 4
D5 DO5 Y5	DVP data output port 5
D6 DO6 Y6	DVP data output port 6
D7 DO7 Y7	DVP data output port 7
D8 DO8 Y8	DVP data output port 8
D9 DO9 Y9	DVP data output port 9
D10 DO10 Y10	DVP data output port 10
D11 DO11 Y11	DVP data output port 11

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Cameras Applications

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Camera Reliability Test

Reliability Inspection Item			Testing Method	Acceptance Criteria
Category		Item		
Environmental	Storage Temperature	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation
Physical	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional
		With Package 60cm	10 Times on Wood Floor	Electrically Functional
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional
	Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional




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Camera Inspection Standard

Inspection Item			Inspection Method	Standard of Inspection
Category		Item		
Appearance	FPC/ PCB	Color	The Naked Eye	Major Difference is Not Allowed.
		Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)
	Holder	Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed
		Gap	The Naked Eye	Meet the Height Standard
		Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed
	Lens	Scratch	The Naked Eye	No Effect On Resolution Standard
		Contamination	The Naked Eye	No Effect On Resolution Standard
		Oil Film	The Naked Eye	No Effect On Resolution Standard
		Cover Tape	The Naked Eye	No Issue On Appearance.
Function	Image	No Communication	Test Board	Not Allowed
		Bright Pixel	Black Board	Not Allowed In the Image Center
		Dark Pixel	White board	Not Allowed In the Image Center
		Blurry	The Naked Eye	Not Allowed
		No Image	The Naked Eye	Not Allowed
		Vertical Line	The Naked Eye	Not Allowed
		Horizontal Line	The Naked Eye	Not Allowed
		Light Leakage	The Naked Eye	Not Allowed
		Blinking Image	The Naked Eye	Not Allowed
		Bruise	Inspection Jig	Not Allowed
		Resolution	Chart	Follows Outgoing Inspection Chart Standard
		Color	The Naked Eye	No Issue
		Noise	The Naked Eye	Not Allowed
		Corner Dark	The Naked Eye	Less Than 100px By 100px
		Color Resolution	The Naked Eye	No Issue
Dimension		Height	The Naked Eye	Follows Approval Data Sheet
		Width	The Naked Eye	Follows Approval Data Sheet
		Length	The Naked Eye	Follows Approval Data Sheet
		Overall	The Naked Eye	Follows Approval Data Sheet

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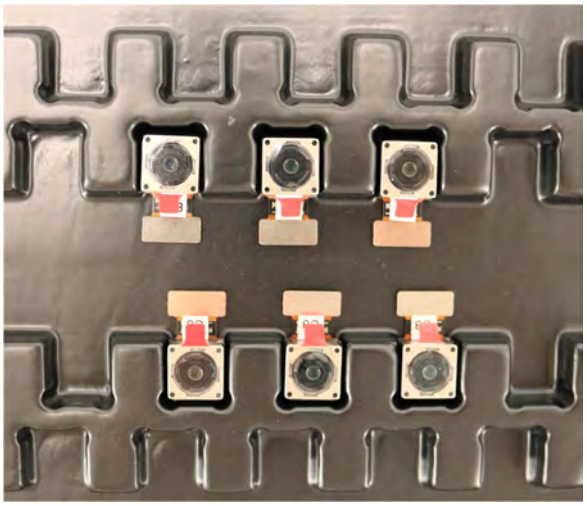
YDS Camera Module

Complete with Lens Protection Film

Tray with Grid and Space

Place Cameras on the Tray



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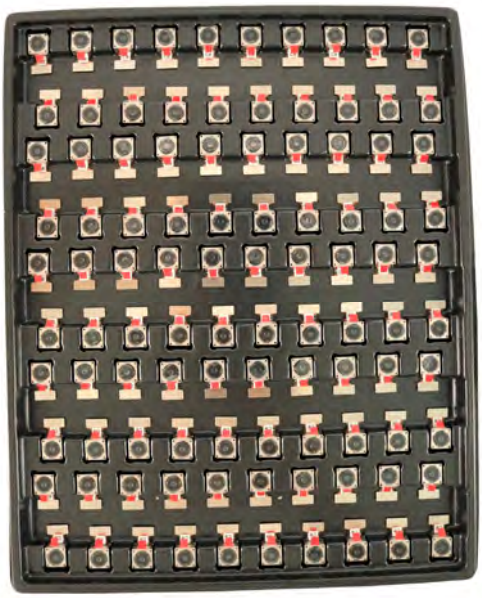
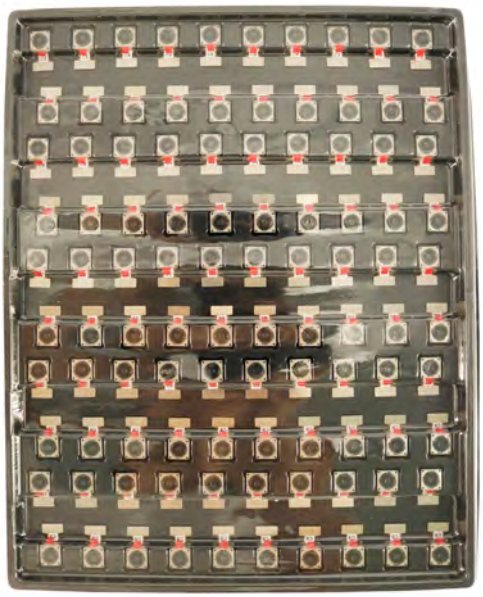
Full Tray of Cameras



Cover Tray with Lid



Place Tray into Anti-Static Bag

Vacuum the Anti-Static Bag

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Sealed Vacuum Anti-Static Bag with Labels

1. Model and Description 2. Quantity 3. Manufacturing Date Code 4. Caution

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Place Foam Sheets Between Tray Bags

Foam Sheets are Larger Than Trays

Place Foam Sheets and Trays into Box

Foam Sheets are Tightly Fitting in Box

Seal the Carbon Box

Label the Carbon Shipping Box

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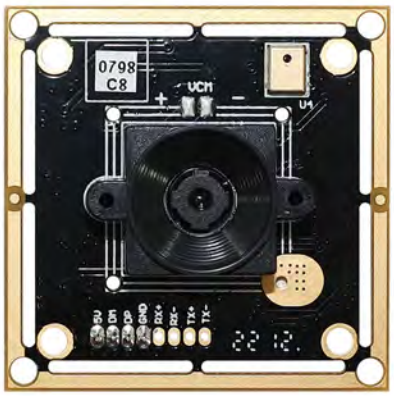
USB Camera Module



Complete with Lens Protection Film

Place Camera Sample into Anti-Static Bag

Place USB Cameras into Tray

Seal the Tray with Anti-Static Bag

Label the Carbon Shipping Box

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Place Camera Sample into Anti-Static Bag

Place Connectors into Anti-Static Bag

Label the Sample Bags

Place Connectors into Reel

Place Samples into the Carbon Box

Place Connectors into the Carbon Box

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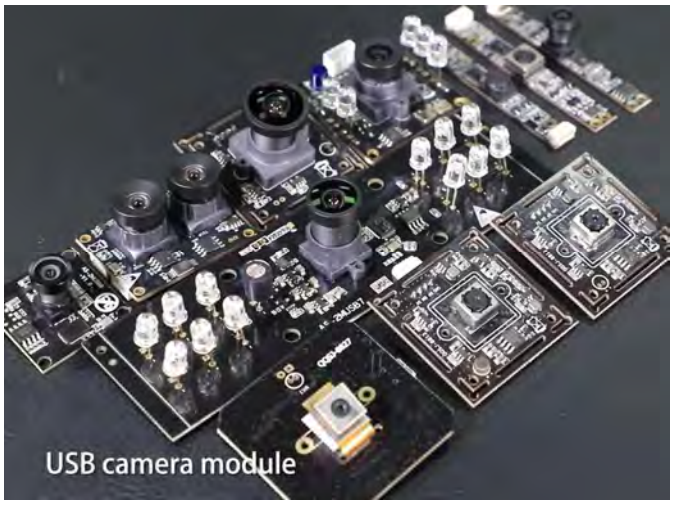
Company YDSCAM

YingDeShun Co. Ltd. (YDS) was established in 2017, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. YDS is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

YDS provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. YDS specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



Limited Warranty

YDS provides the following limited warranty if you purchased the Product(s) directly from YDS company or from YDS's website www.YDSCAM.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. YDS guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, YDS will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of YDS is solely limited to repair and/or replacement on the terms set forth above. YDS is not reliable or responsible for any subsequential events.

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